

TNY264/266-268

TinySwitch™ -II Family

Enhanced, Energy Efficient,
Low Power Off-line Switcher



Product Highlights

TinySwitch-II Features Reduce System Cost

- Fully integrated auto-restart for short circuit and open loop fault protection - saves external component costs
- Built-in circuitry practically eliminates audible noise with standard varnished transformer
- Programmable line under-voltage detect feature prevents power on/off glitches - saves external components
- Frequency jittering dramatically reduces EMI (~10 dB) - minimizes EMI filter component costs
- 132 kHz operation reduces transformer size - allows use of EF12.6 or EE13 cores for low cost and small size
- Very tight tolerances and negligible temperature variation on key parameters eases design and lowers cost
- Lowest component count switcher solution

Better Cost/Performance over RCC & Linears

- Lower system cost than RCC, discrete PWM and other integrated/hybrid solutions
- Cost effective replacement for bulky regulated linears
- Simple ON/OFF control - no loop compensation needed
- No bias winding - simpler, lower cost transformer

Extremely Energy Efficient

- No load consumption < 50 mW with bias winding and < 250 mW without bias winding at 265 VAC input
- Meets Blue Angel, Energy Star, and EC requirements for standby power consumption
- Ideal for cell-phone charger and PC standby applications

High Performance at Low Cost

- High voltage powered - ideal for charger applications
- High bandwidth provides fast turn on with no overshoot
- Current limit operation rejects line frequency ripple
- Built-in current limit and thermal protection

Description

TinySwitch-II maintains the simplicity of the *TinySwitch* topology, while providing a number of new enhancements to further reduce system cost, component count and audible noise. Like *TinySwitch*, a 700 V power MOSFET, oscillator, high voltage switched current source, current limit and thermal shutdown circuitry are integrated onto a monolithic device. The start-up and operating power are derived directly from the voltage on the DRAIN, eliminating the need for a transformer bias winding and associated circuitry. In addition, the

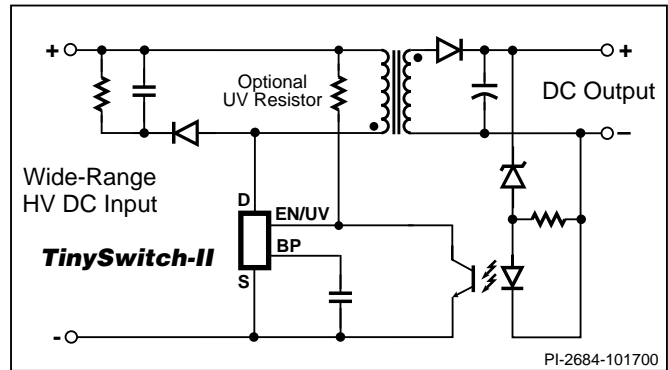


Figure 1. Typical Standby Application.

OUTPUT POWER TABLE				
PRODUCT ³	230 VAC ±15%		85-265 VAC	
	Adapter ¹	Open Frame ²	Adapter ¹	Open Frame ²
TNY264P or G	5.5 W	9 W	4 W	6 W
TNY266P or G	10 W	15 W	6 W	9.5 W
TNY267P or G	13 W	19 W	8 W	12 W
TNY268P or G	16 W	23 W	10 W	15 W

Table 1. Notes: **1.** Typical continuous power in a non-ventilated enclosed adapter measured at 50 °C ambient. **2.** Maximum practical continuous power in an open frame design with adequate heat sinking, measured at 50 °C ambient (See key applications section for details). **3.** Packages: P: DIP-8B, G: SMD-8B. Please see part ordering information.

TinySwitch-II devices incorporate auto-restart, line under-voltage sense, and frequency jittering. An innovative design minimizes audio frequency components in the simple ON/OFF control scheme to practically eliminate audible noise with standard taped/varnished transformer construction. The fully integrated auto-restart circuit safely limits output power during fault conditions such as output short or open loop, reducing component count and secondary feedback circuitry cost. The line under-voltage sense threshold can be externally programmed using an optional line sense resistor, eliminating power down glitches caused by the slow discharge of input storage capacitors present in applications such as standby supplies. The operating frequency of 132 kHz is jittered to significantly reduce both the quasi-peak and average EMI, minimizing filtering cost.

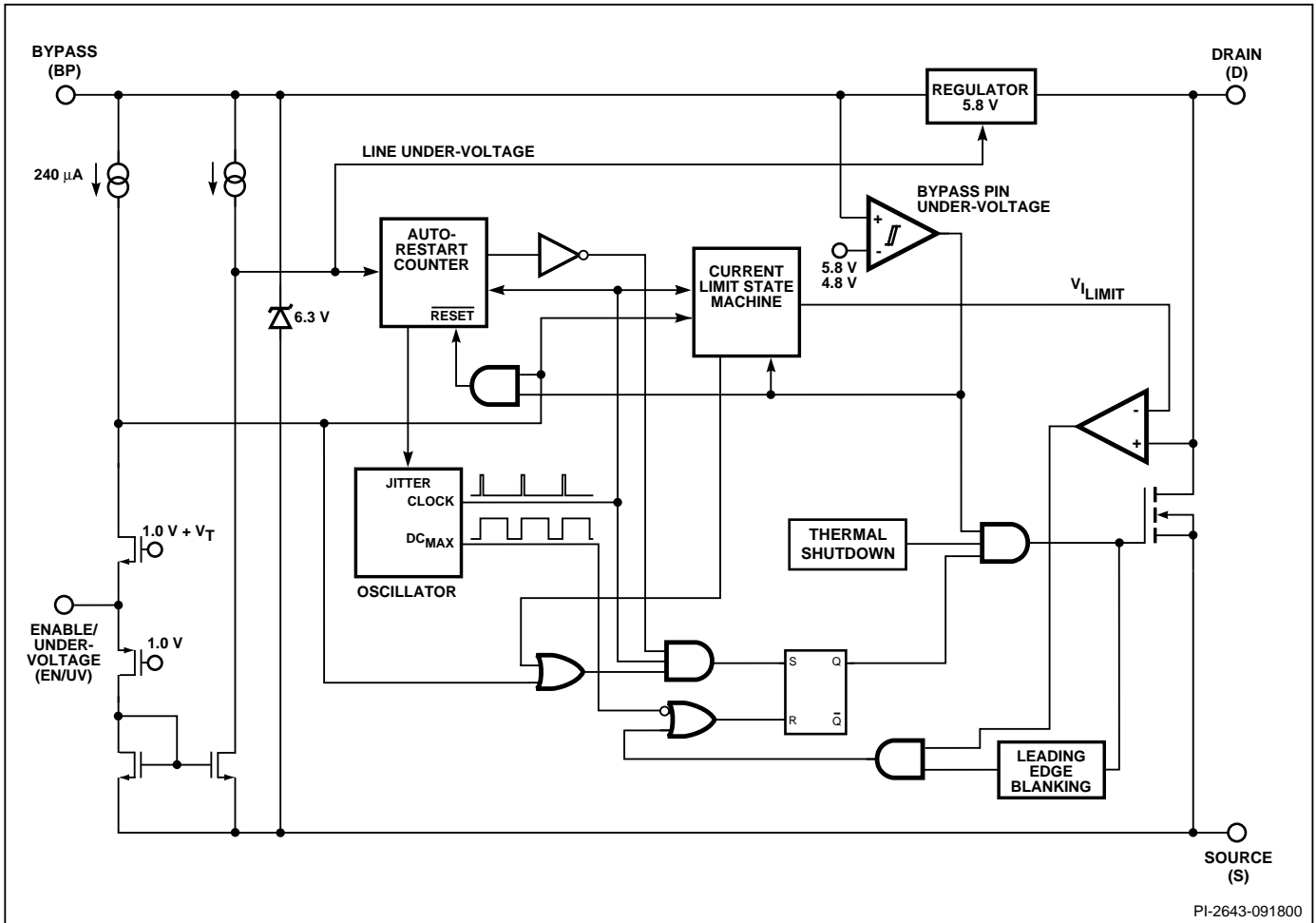


Figure 2. Functional Block Diagram.

Pin Functional Description

DRAIN (D) Pin:

Power MOSFET drain connection. Provides internal operating current for both start-up and steady-state operation.

BYPASS (BP) Pin:

Connection point for a 0.1 μF external bypass capacitor for the internally generated 5.8 V supply.

ENABLE/UNDER-VOLTAGE (EN/UV) Pin:

This pin has dual functions, enable input and line under-voltage sense. During normal operation, switching of the power MOSFET is controlled by this pin. MOSFET switching is terminated when a current greater than 240 μA is drawn out of this pin under most loads. However, at high load levels, even when more than 240 μA is drawn out of this pin the MOSFET switching still occurs, but at a predetermined lower current limit level. This pin also senses line under-voltage conditions through an external resistor connected to the DC line voltage. If there is no external resistor connected to this pin, *TinySwitch-II* detects this and disables the line under-voltage function.

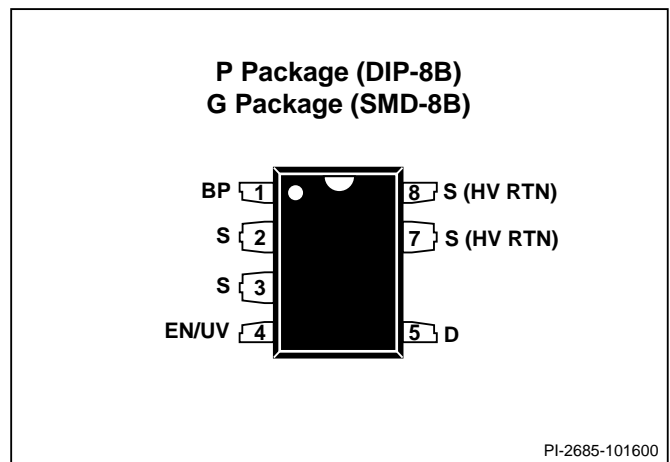


Figure 3. Pin Configuration.

SOURCE (S) Pin:

Control circuit common, internally connected to output MOSFET source.

SOURCE (HV RTN) Pin:

Output MOSFET source connection for high voltage return.

TinySwitch-II Functional Description

TinySwitch-II combines a high voltage power MOSFET switch with a power supply controller in one device. Unlike conventional PWM (Pulse Width Modulator) controllers, *TinySwitch-II* uses a simple ON/OFF control to regulate the output voltage.

The *TinySwitch-II* controller consists of an Oscillator, Enable Circuit (Sense and Logic), Current Limit State Machine, 5.8 V Regulator, Bypass pin Under-Voltage Circuit, Over Temperature Protection, Current Limit Circuit, Leading Edge Blanking and a 700 V power MOSFET. *TinySwitch-II* incorporates additional circuitry for Line Under-Voltage Sense, Auto-Restart and Frequency Jitter. Figure 2 shows the functional block diagram with the most important features.

Oscillator

The typical oscillator frequency is internally set to an average of 132 kHz. Two signals are generated from the oscillator, the Maximum Duty Cycle signal (DC_{MAX}) and the Clock signal that indicates the beginning of each cycle.

The *TinySwitch-II* oscillator incorporates circuitry that introduces a small amount of frequency jitter, typically 8 kHz peak-to-peak, to minimize EMI emission. The modulation rate of the frequency jitter is set to 1 kHz to optimize EMI reduction for both average and quasi-peak emissions. The frequency jitter should be measured with the oscilloscope triggered at the falling edge of the DRAIN waveform. The waveform in Figure 4 illustrates the frequency jitter of the *TinySwitch-II*.

Enable Input and Current Limit State Machine

The enable input circuit at the EN/UV pin consists of a low impedance source follower output set at 1.0 V. The current through the source follower is limited to 240 μ A. When the current drawn out of this pin exceeds 240 μ A, a low logic level

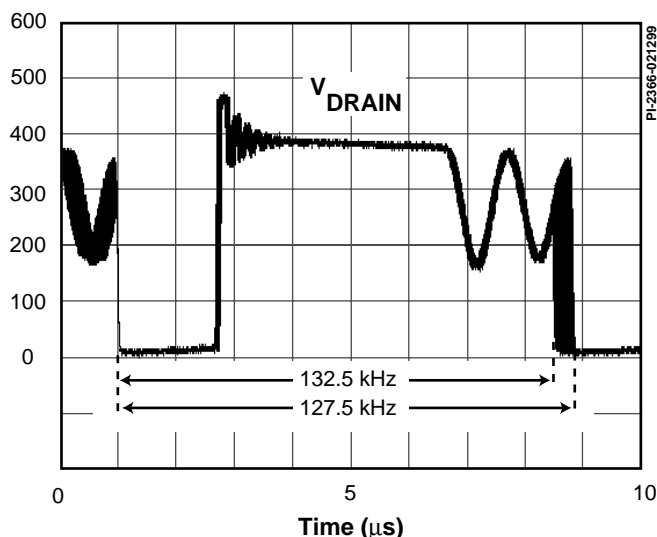


Figure 4. Frequency Jitter.

(disable) is generated at the output of the enable circuit. This enable circuit output is sampled at the beginning of each cycle on the rising edge of the clock signal. Under most load conditions, if high, the power MOSFET is turned on for that cycle (enabled), otherwise the power MOSFET remains off (disabled). At very high loads, even when a low logic level is generated at the output of the enable circuitry, the power MOSFET is still turned on for that cycle (enabled), but the current limit is reduced to a predetermined level (typically 50% of the specified current limit). Since the sampling is done only at the beginning of each cycle, subsequent changes in the EN/UV pin voltage or current during the remainder of the cycle are ignored.

The Current Limit State Machine reduces the current limit by discrete amounts at light loads when *TinySwitch-II* is likely to switch in the audible frequency range. The lower current limit reduces the transformer flux density and the associated audible noise. At very high loads, the state machine prevents cycle skipping and thus reduces the audible frequency components associated with it. The state machine monitors the sequence of EN/UV pin voltage levels to determine the load condition and adjusts the current limit level accordingly in discrete amounts.

Under most operating conditions (except when close to no-load), the low impedance of the source follower keeps the voltage on the EN/UV pin from going much below 1.0 V in the disabled state. This improves the response time of the optocoupler that is usually connected to this pin.

5.8 V Regulator and 6.3 V Shunt Voltage Clamp

The 5.8 V regulator charges the bypass capacitor connected to the BYPASS pin to 5.8 V by drawing a current from the voltage on the DRAIN, whenever the MOSFET is off. The BYPASS pin is the internal supply voltage node for the *TinySwitch-II*. When the MOSFET is on, the *TinySwitch-II* runs off of the energy stored in the bypass capacitor. Extremely low power consumption of the internal circuitry allows *TinySwitch-II* to operate continuously from the current drawn from the DRAIN pin. A bypass capacitor value of 0.1 μ F is sufficient for both high frequency decoupling and energy storage.

In addition, there is a 6.3 V shunt regulator clamping the BYPASS pin at 6.3 V when current is provided to the BYPASS pin through an external resistor. This facilitates powering of *TinySwitch-II* externally through a bias winding to decrease the no load consumption to about 50 mW.

BYPASS Pin Under-Voltage

The BYPASS pin under-voltage circuitry disables the power MOSFET when the BYPASS pin voltage drops below 4.8 V. Once the BYPASS pin voltage drops below 4.8 V, it must rise back to 5.8 V to enable (turn-on) the power MOSFET.

Over Temperature Protection

The thermal shutdown circuitry senses the die temperature. The threshold is set at 135 °C with 70 °C hysteresis. When the die temperature rises above this threshold (135 °C) the power MOSFET is disabled and remains disabled until the die temperature falls by 70 °C, at which point it is re-enabled.

Current Limit

The current limit circuit senses the current in the power MOSFET. When this current exceeds the internal threshold (I_{LIMIT}), the power MOSFET is turned off for the remainder of that cycle. The current limit state machine reduces the current limit threshold by discrete amounts under medium and light loads.

The leading edge blanking circuit inhibits the current limit comparator for a short time (t_{LEB}) after the power MOSFET is turned on. This leading edge blanking time has been set so that current spikes caused by capacitance and secondary-side rectifier reverse recovery time will not cause premature termination of the switching pulse.

Auto-Restart

In the event of a fault condition such as output overload, output short, or an open loop condition, *TinySwitch-II* enters into auto-restart operation. An internal counter clocked by the oscillator gets reset every time the EN/UV pin is pulled low. If the EN/UV pin is not pulled low for 50 ms, the power MOSFET switching is disabled for 850 ms (except in the case of line under-voltage condition in which case it is disabled until the condition is removed). The auto-restart alternately enables and disables the switching of the power MOSFET until the fault condition is removed. Figure 5 illustrates auto-restart circuit operation in the presence of an output short.

In the event of a line under-voltage condition, the switching of the power MOSFET is disabled beyond its normal 850 ms time until the line under-voltage condition ends.

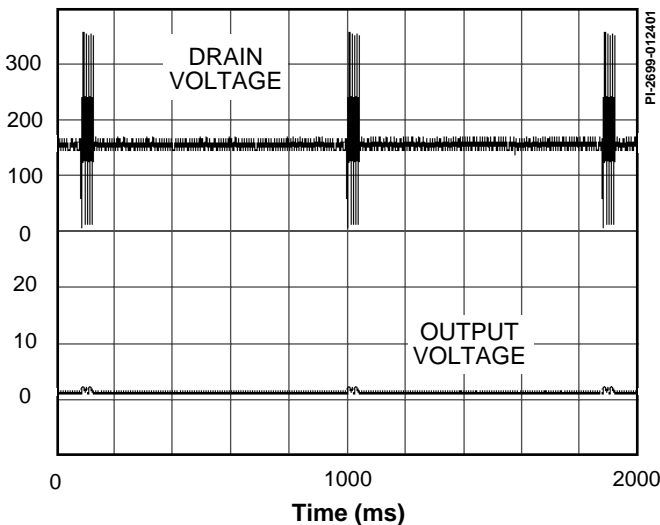


Figure 5. *TinySwitch-II* Auto-Restart Operation.

Line Under-Voltage Sense Circuit

The DC line voltage can be monitored by connecting an external resistor from the DC line to the EN/UV pin. During power-up or when the switching of the power MOSFET is disabled in auto-restart, the current into the EN/UV pin must exceed 50 μ A to initiate switching of the power MOSFET. During power-up, this is implemented by holding the BYPASS pin to 4.8 V while the line under-voltage condition exists. The BYPASS pin then rises from 4.8 V to 5.8 V when the line under-voltage condition goes away. When the switching of the power MOSFET is disabled in auto-restart mode and a line under-voltage condition exists, the auto-restart counter is stopped. This stretches the disable time beyond its normal 850 ms until the line under-voltage condition ends.

The line under-voltage circuit also detects when there is no external resistor connected to the EN/UV pin. In this case the line under-voltage function is disabled.

***TinySwitch-II* Operation**

TinySwitch-II devices operate in the current limit mode. When enabled, the oscillator turns the power MOSFET on at the beginning of each cycle. The MOSFET is turned off when the current ramps up to the current limit or the DC_{MAX} limit is reached. As the highest current limit level and frequency of a *TinySwitch-II* design are constant, the power delivered to the load is proportional to the primary inductance of the transformer and peak primary current squared. Hence designing the supply involves calculating the primary inductance of the transformer for the maximum output power required. If the *TinySwitch-II* is appropriately chosen for the power level, the current in the calculated inductance will ramp up to current limit before the DC_{MAX} limit is reached.

Enable Function

TinySwitch-II senses the EN/UV pin to determine whether or not to proceed with the next switch cycle as described earlier. The sequence of cycles is used to determine the current limit. Once a cycle is started, it always completes the cycle (even when the EN/UV pin changes state half way through the cycle). This operation results in a power supply in which the output voltage ripple is determined by the output capacitor, amount of energy per switch cycle and the delay of the feedback.

The EN/UV pin signal is generated on the secondary by comparing the power supply output voltage with a reference voltage. The EN/UV pin signal is high when the power supply output voltage is less than the reference voltage.

In a typical implementation, the EN/UV pin is driven by an optocoupler. The collector of the optocoupler transistor is connected to the EN/UV pin and the emitter is connected to the SOURCE pin. The optocoupler LED is connected in series with a Zener across the DC output voltage to be regulated. When the



output voltage exceeds the target regulation voltage level (optocoupler LED voltage drop plus Zener voltage), the optocoupler LED will start to conduct, pulling the EN/UV pin low. The Zener can be replaced by a TL431 reference for improved accuracy.

ON/OFF Operation with Current Limit State Machine

The internal clock of the *TinySwitch-II* runs all the time. At the beginning of each clock cycle, it samples the EN/UV pin to decide whether or not to implement a switch cycle and based on

the sequence of samples over multiple cycles, it determines the appropriate current limit. At high loads, when the EN/UV pin is high (less than 240 μ A pulled out of the pin), then a switching cycle with the full current limit occurs. At lighter loads, when EN/UV is high, then a switching cycle with a reduced current limit occurs.

Under most load conditions, when the EN/UV pin is low (more than 240 μ A pulled out of the pin), no switching cycle occurs. However, at very high loads, when the EN/UV pin is low, a switching cycle with reduced current limit occurs. The EN/UV pin status is sampled again at the start of the subsequent clock cycle.

At nearly full load, *TinySwitch-II* will conduct during all of its clock cycles (Figure 6). EN/UV only modulates the current limit between two distinct levels. At slightly lower loads, it will “skip” cycles in order to maintain voltage regulation at the power supply output (Figure 7). At medium loads, cycles will be skipped and the current limit will be reduced (Figure 8). At very light loads, the current limit will be reduced even further (Figure 9). Only a small percentage of cycles will occur to satisfy the power consumption of the power supply.

The response time of the *TinySwitch-II* ON/OFF control scheme is very fast compared to normal PWM control. This provides tight regulation and excellent transient response.

Power Up/Down

The *TinySwitch-II* requires only a 0.1 μ F capacitor on the BYPASS pin. Because of the small size of this capacitor, the time to charge this capacitor is kept to an absolute minimum, typically 0.6 ms. Due to the fast nature of the ON/OFF feedback,

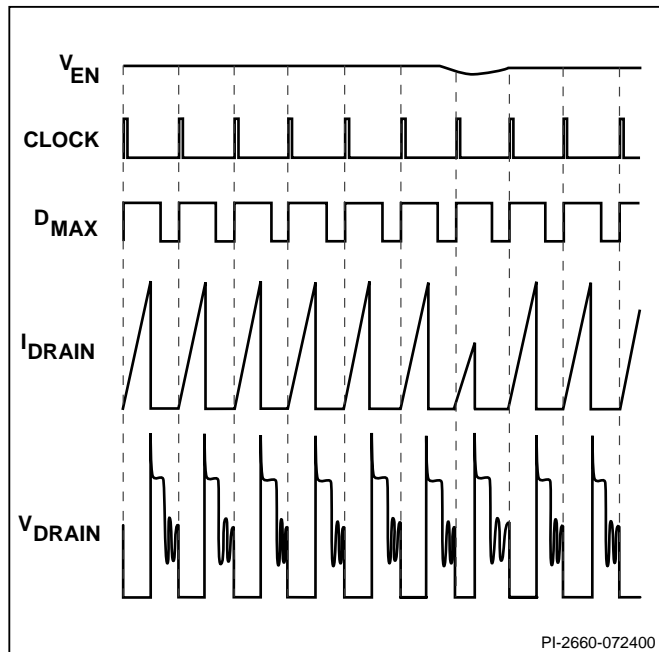


Figure 6. *TinySwitch-II* Operation at Very Heavy Load.

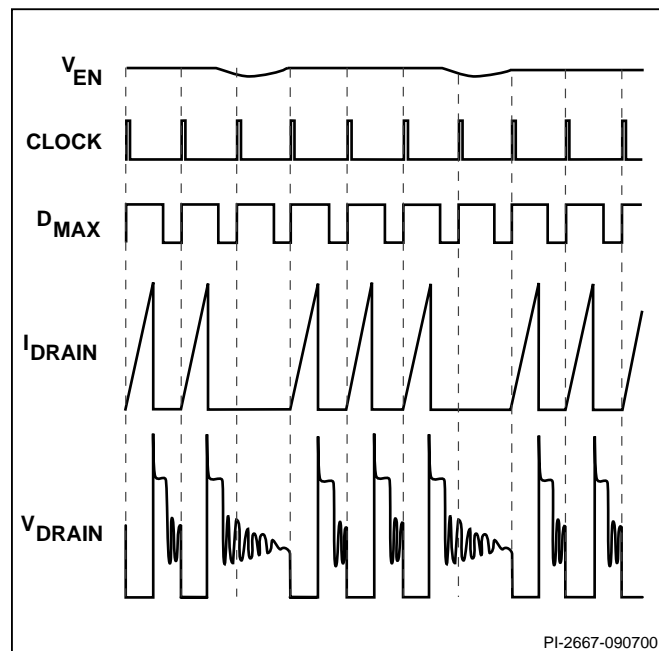


Figure 7. *TinySwitch-II* Operation at Reasonably Heavy Load.

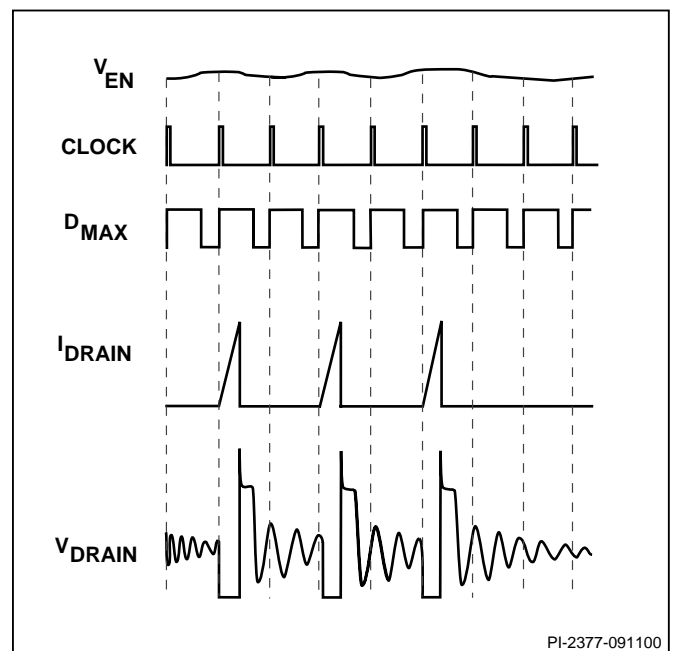


Figure 8. *TinySwitch-II* Operation at Medium Load.



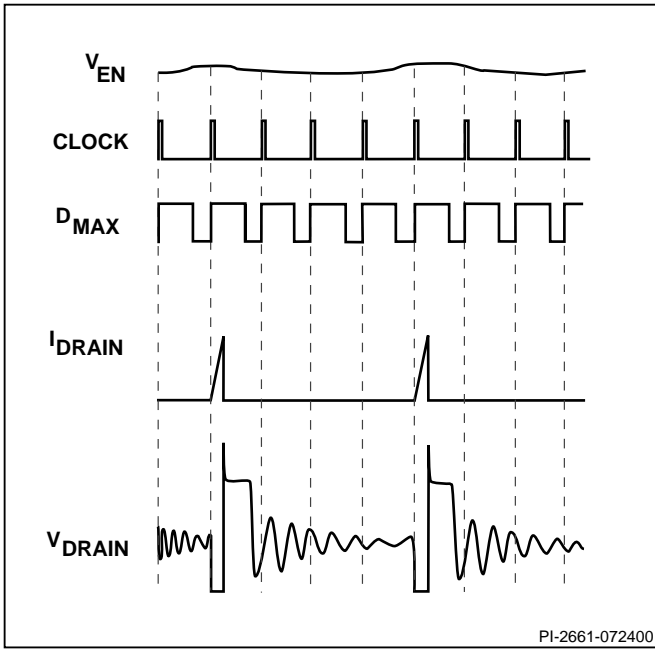


Figure 9. TinySwitch-II Operation at Very Light Load.

there is no overshoot at the power supply output. When an external resistor ($2\text{ M}\Omega$) is connected to the EN/UV pin, the power MOSFET switching will be delayed during power-up until the DC line voltage exceeds the threshold (100 V). Figures 10 and 11 show the power-up timing waveform of *TinySwitch-II* in applications with and without an external resistor ($2\text{ M}\Omega$) connected to the EN/UV pin.

During power-down, when an external resistor is used, the power MOSFET will switch for 50 ms after the output loses regulation. The power MOSFET will then remain off without any glitches since the under-voltage function prohibits restart when the line voltage is low.

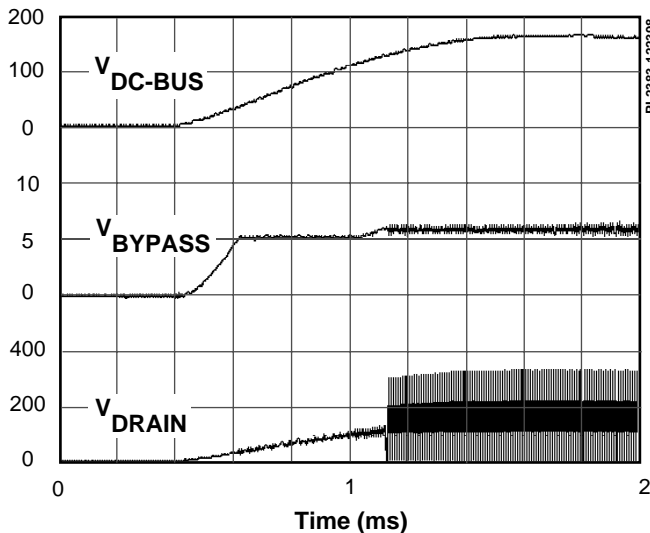


Figure 10. TinySwitch-II Power-up With External Resistor ($2\text{ M}\Omega$) Connected to EN/UV Pin.

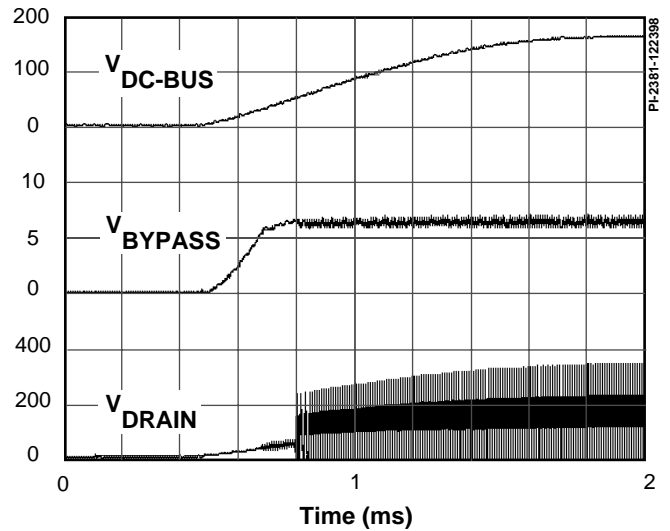


Figure 11. TinySwitch-II Power-up Without External Resistor Connected to EN/UV Pin.

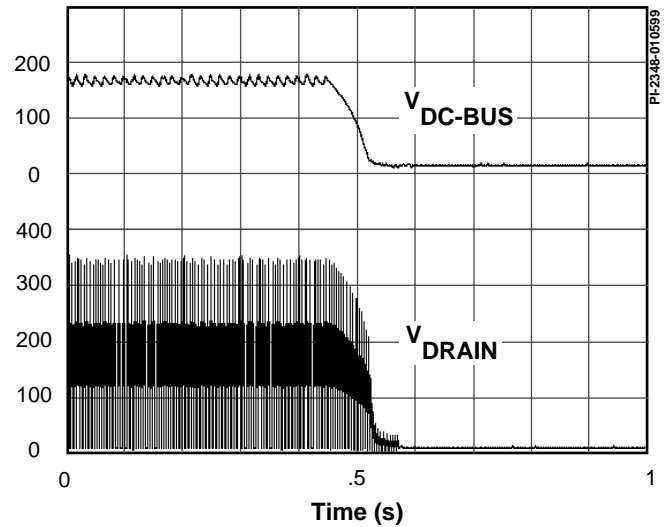


Figure 12. Normal Power-down Timing.

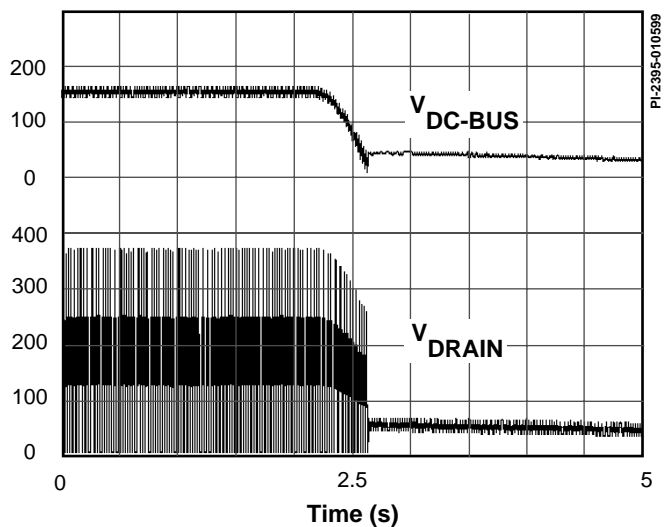
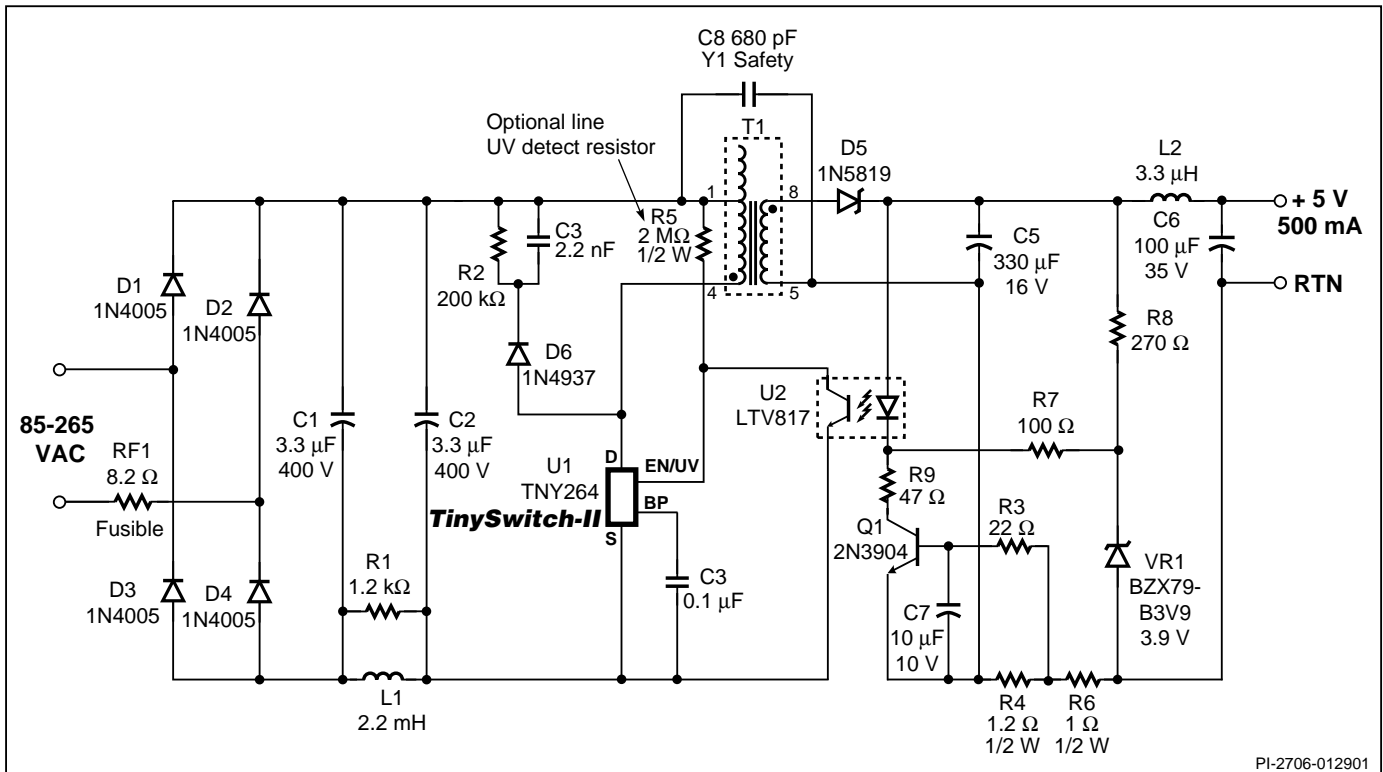


Figure 13. Slow Power-down Timing with External ($2\text{ M}\Omega$) Resistor Connected to EN/UV Pin.



PI-2706-012901

Figure 14. 2.5 W Constant Current, Constant Voltage Battery Charger with Universal Input (85 - 265 VAC).

Figure 12 illustrates a typical power-down timing waveform of *TinySwitch-II*. Figure 13 illustrates a very slow power-down timing waveform of *TinySwitch-II* as in standby applications. The external resistor (2 MΩ) is connected to the EN/UV pin in this case to prevent unwanted restarts.

The *TinySwitch-II* does not require a bias winding to provide power to the chip, because it draws the power directly from the DRAIN pin (see Functional Description above). This has two main benefits. First, for a nominal application, this eliminates the cost of an extra bias winding and associated components. Secondly, for charger applications, the current-voltage characteristic often allows the output voltage to fall to low values while still delivering power. This type of application normally requires a forward-bias winding which has many more associated components. With *TinySwitch-II*, neither are necessary. For applications that require a very small power consumption (50 mW), a resistor from a bias winding to the BYPASS pin can provide the power to the chip. The BYPASS pin in this case will be clamped at 6.3 V. This method will eliminate the drawing of the power from the DRAIN pin, thereby reducing the no-load power consumption and improving full-load efficiency.

Current Limit Operation

Each switching cycle is terminated when the DRAIN current reaches the current limit of the *TinySwitch-II*. For a given primary inductance and input voltage, the duty cycle is constant.

However, the duty cycle does change inversely with the input voltage providing “voltage feed-forward” advantages: good line ripple rejection and relatively constant power delivery independent of the input voltage.

BYPASS Pin Capacitor

The BYPASS pin uses a small 0.1 μF ceramic capacitor for decoupling the internal power supply of the *TinySwitch-II*.

Application Examples

The *TinySwitch-II* is ideal for low cost, high efficiency power supplies in a wide range of applications such as cellular phone chargers, TV standby, AC adapters, motor control, appliance control and ISDN network termination. The 132 kHz operation allows the use of a low cost EE13 or EF12.6 core transformer while still providing good efficiency. The frequency jitter in *TinySwitch-II* makes it possible to use a single inductor (or two small resistors if lower efficiency is acceptable) in conjunction with two input capacitors for input EMI filtering. The auto-restart function removes the need to oversize the output diode for short circuit conditions allowing the design to be optimized for low cost and maximum efficiency. In charger applications, it eliminates the need for a second optocoupler and Zener diode for open loop fault protection. Auto-restart also saves the cost of adding a fuse or increasing the power rating of the current sense resistors to survive reverse battery conditions. For applications requiring under-voltage lock out (UVLO), the



TinySwitch-II eliminates several components and saves cost. *TinySwitch-II* is well suited for applications that require constant voltage and constant current output. As *TinySwitch-II* is always powered from the input high voltage, it therefore does not require a bias winding for operating power. Consequently, its operation is not dependant on the level of the output voltage. This greatly simplifies designing chargers that must work down to zero volts on the output.

As an example, Figure 14 shows a TNY264 based 5 V, 0.5 A, cellular phone charger operating over a universal input range (85-265 VAC). The AC input is rectified and filtered by D1 – D4, C1 and C2 to create a high voltage DC bus connected to T1 and in series with the high voltage MOSFET inside the TNY264. The inductor (L1) forms a π -filter in conjunction with C1 and C2. The resistor R1 damps resonances in the inductor L1. Frequency jittering operation of *TinySwitch-II* allows the use of a simple π -filter described above in combination with a single low value Y1-capacitor (C8) to meet worldwide conducted EMI standards. The addition of a shield winding in the transformer allows EMI to be met even with the output capacitively earthed. The diode D6, capacitor C3 and resistor R2 comprise the clamp circuit, clamping the leakage inductance turn-off voltage spike on the *TinySwitch-II* DRAIN pin to a safe value. The secondary winding is rectified and filtered by D5 and C5 to provide the 5 V output. Additional filtering is provided by L2 and C6. The output voltage is determined by the sum of the optocoupler U2 LED forward drop (~1 V), and Zener diode VR1 voltage. Resistor R8 maintains a bias current through the Zener to ensure it is operated close to the Zener test current.

A simple constant current circuit is implemented using the V_{BE} of transistor Q1 to sense the voltage across the current sense resistor R4. When the drop across R4 exceeds the V_{BE} of transistor Q1, it turns on and takes over control of the loop by driving the optocoupler LED. Resistor R6 provides additional voltage to keep the control loop in operation down to zero volts at the output. With the output shorted, the drop across R4 and R6 (~1.2 V) is sufficient to keep the Q1 and LED circuit active. Resistors R7 and R9 limit the forward current that could be drawn through VR1 by Q1 under output short circuit conditions, due to the voltage drop across R4 and R6.

R5 (optional) provides line under-voltage detect. At power-up operation is inhibited until 50 μ A flows into the EN/UV pin. With a 2 M Ω resistor as shown, this occurs at 100 VDC. This resistor also prevents the output glitching on power down.

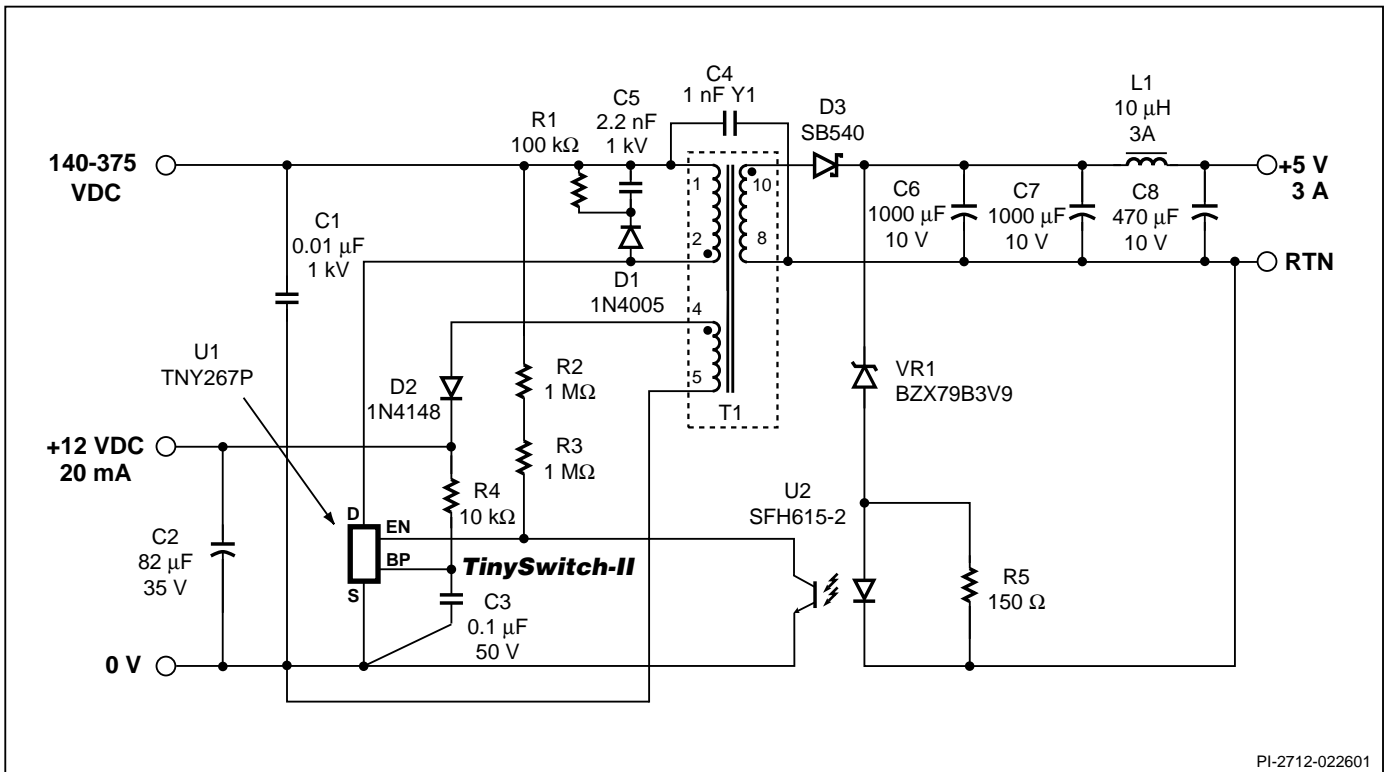
Figures 15 and 16 show examples of circuits for PC standby applications. They both provide two outputs, an isolated 5 V and a 12 V primary referenced output. The first, using TNY266P, provides 10 W and the second, using TNY267P, 15 W of output power. Both operate from an input range of 140 to 375 VDC, corresponding to a 230 VAC or 100/115 VAC with doubler input. The designs take advantage of the line under-voltage detect, auto-restart and higher switching frequency of *TinySwitch-II*. Operation at 132 kHz allows the use of a smaller and lower cost transformer core, EE16 for 10 W and EE22 for 15 W. The removal of pin 6 from the 8 pin DIP *TinySwitch* packages provides a large creepage distance which improves reliability in high pollution environments such as fan cooled PC power supplies.

Capacitor C1 provides high frequency decoupling of the high voltage DC supply, only necessary if there is a long trace length from the DC bulk capacitors of the main supply. The line sense resistors R2 and R3 sense the DC input voltage for line under-voltage. When the AC is turned off, the under-voltage detect feature of the *TinySwitch-II* prevents auto-restart glitches at the output caused by the slow discharge of large storage capacitance in the main converter. This is achieved by preventing the *TinySwitch-II* from switching when the input voltage goes below a level needed to maintain output regulation, and keeping it off until the input voltage goes above the under-voltage threshold, when the AC is turned on again. With R2 and R3, giving a combined value of 2 M Ω , the under-voltage threshold is set at 200 VDC, slightly below the lowest required operating DC input voltage, for start-up at 170 VAC. This feature saves several components needed to implement the glitch-free turn-off compared with discrete or *TOPSwitch-II* based designs.

The auxiliary, primary side, winding is rectified and filtered by D2 and C2 to create a 12 V primary bias output voltage for the main power supply primary controller. In addition, via R4, this voltage is used to power the *TinySwitch-II*. Although not necessary for operation, supplying the *TinySwitch-II* externally reduces the device dissipation by disabling the internal drain derived current source normally used to keep the BYPASS pin capacitor (C3) charged.

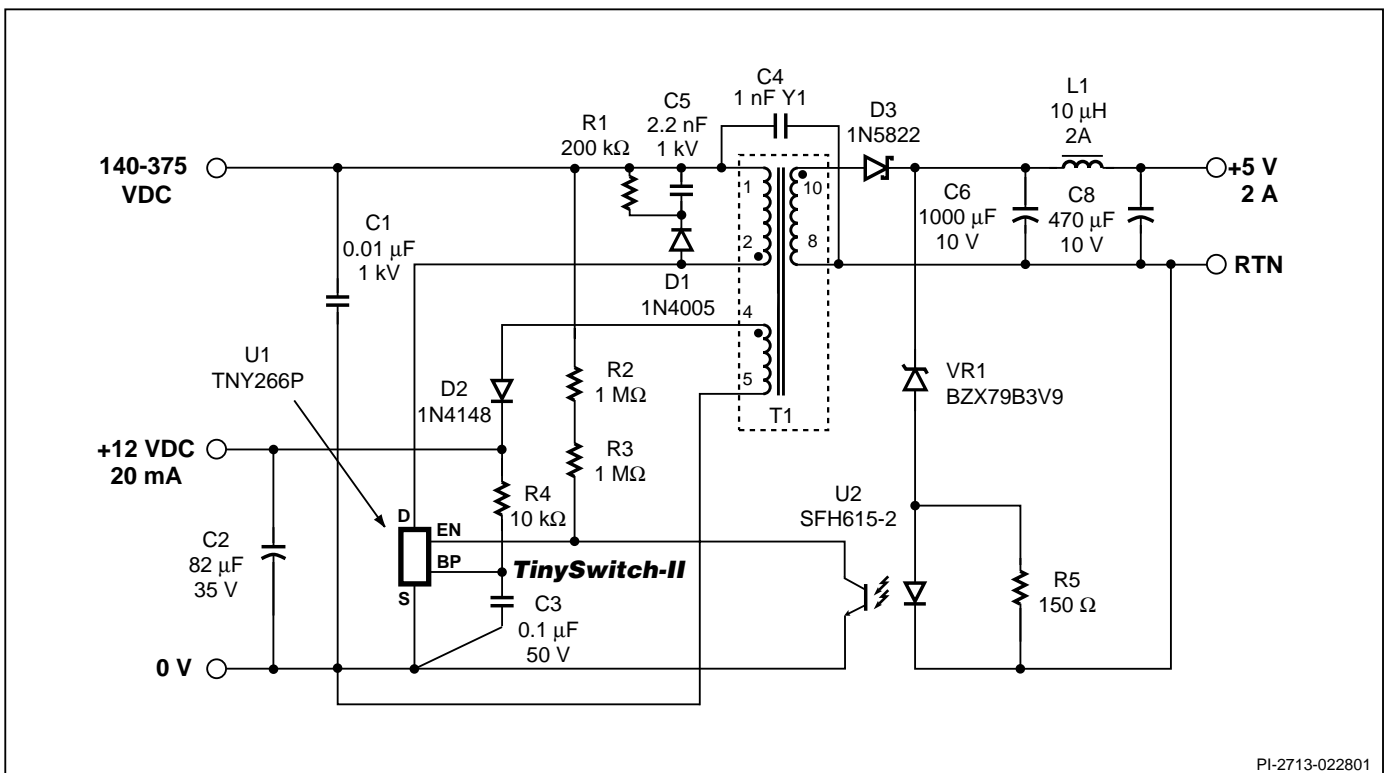
The secondary winding is rectified and filtered by D3 and C6. For a 15 W design an additional output capacitor, C7, is required due to the large secondary ripple currents. The auto-restart function limits output current during short circuit conditions, removing the need to over rate D3. Switching noise filtering is provided by L1 and C8. The 5 V output is sensed by U2 and VR1. R5 is used to ensure that the Zener is biased at its test current.





PI-2712-022601

Figure 15. 10 W PC Standby Supply.



PI-2713-022801

Figure 16. 15 W PC Standby Supply.



Key Application Considerations

TinySwitch-II vs. **TinySwitch**

Table 2 compares the features and performance differences between the TNY254 device of the *TinySwitch* family with the *TinySwitch-II* family of devices. Many of the new features

eliminate the need for or reduce the cost of circuit components. Other features simplify the design and enhance performance.

Function	TinySwitch TNY254	TinySwitch-II TNY264/266-268	TinySwitch-II Advantages
Switching Frequency and Tolerance Temperature Variation (0 - 100 °C)**	44 kHz ±10% (@25 °C) +8%	132 kHz ±6% (@25 °C) +2%	<ul style="list-style-type: none"> • Smaller transformer for low cost • Ease of design • Manufacturability • Optimum design for lower cost
Active Frequency Jitter	N/A*	±4 kHz	<ul style="list-style-type: none"> • Lower EMI minimizing filter component costs
Transformer Audible Noise Reduction	N/A*	Yes - built into controller	<ul style="list-style-type: none"> • Practically eliminates audible noise with standard dip varnished transformer – no special construction or gluing required
Line UV Detect	N/A*	Single resistor programmable	<ul style="list-style-type: none"> • Prevents power on/off glitches
Current Limit Tolerance Temperature Variation (0 - 100 °C)**	± 11% (@25 °C) -8%	± 7% (@25 °C) 0%	<ul style="list-style-type: none"> • Increases power capability and simplifies design for high volume manufacturing
Auto-Restart	N/A	6% effective on-time	<ul style="list-style-type: none"> • Limits output short-circuit current to less than full load current - No output diode size penalty. • Protects load in open loop fault conditions - No additional components required
Drain Creepage at Package	0.037" / 0.94 mm	0.137" / 3.48 mm	<ul style="list-style-type: none"> • Greater immunity to arcing as a result of dust, debris or other contaminants build-up

*Not available. ** See typical performance curves.

Table 2. Comparison Between *TinySwitch* and *TinySwitch-II*.

Design

Output Power

Table 1 shows the practical maximum continuous output power levels that can be obtained under the following conditions:

1. The minimum DC input voltage is 90 V or higher for 85 VAC input, or 240 V or higher for 230 VAC input or 115 VAC input with a voltage doubler. This corresponds to a filter capacitor of 3 mF/W for universal input and 1 mF/W for 230 or 115 VAC w/doubler input.
2. A secondary output of 5 V with a Schottky rectifier diode.
3. Assumed efficiency of 77% (TNY267 & TNY268), 75% (TNY266) and 73% (TNY264).
4. The parts are board mounted with SOURCE pins soldered to sufficient area of copper to keep the die temperature at or below 100 °C.



In addition to the thermal environment (sealed enclosure, ventilated, open frame, etc.), the maximum power capability of *TinySwitch-II* in a given application depends on transformer core size and design (continuous or discontinuous), efficiency required, minimum specified input voltage, input storage capacitance, output voltage, output diode forward drop, etc., and can be different from the values shown in Table 1.

Audible Noise

The *TinySwitch-II* practically eliminates any transformer audio noise using simple standard varnished transformer construction. No gluing of the cores is needed. The audio noise reduction is accomplished by the *TinySwitch-II* controller reducing the current limit in discrete steps as the load is reduced. This minimizes the peak flux density in the transformer when switching at audio frequencies.

Layout

Single Point Grounding

Use a single point ground connection at the SOURCE pin for the BYPASS pin capacitor and the Input Filter Capacitor (see Figure 17).

Primary Loop Area

The area of the primary loop that connects the input filter capacitor, transformer primary and *TinySwitch-II* together, should be kept as small as possible.

Primary Clamp Circuit

A clamp is used to limit peak voltage on the DRAIN pin at turn-off. This can be achieved by using an RCD clamp (as shown in Figure 14). A Zener and diode clamp across the primary or a single 550 V Zener clamp from DRAIN to SOURCE can also be used. In all cases care should be taken to minimize the circuit path from the clamp components to the transformer and *TinySwitch-II*.

Thermal Considerations

Copper underneath the *TinySwitch-II* acts not only as a single point ground, but also as a heatsink. The hatched areas shown in Figure 17 should be maximized for good heat sinking of *TinySwitch-II* and output diode.

EN/UV pin layout optimization

The EN/UV pin connection to the optocoupler should be kept to an absolute minimum (less than 0.5 in.), and this connection should be kept away from the DRAIN pin (minimum of 0.2 in.). If a line under-voltage detect resistor is used then the resistor should be mounted as close as possible to the EN/UV pin to minimize noise pick up.

Y-Capacitor

The placement of the Y-capacitor should be directly from the primary bulk capacitor positive to the common/return terminal on the secondary side. Such placement will maximize the EMI benefit of the Y-capacitor.

Optocoupler

It is important to maintain the minimum circuit path from the optocoupler transistor to the *TinySwitch-II* EN/UV and SOURCE pins to minimize noise coupling.

Output Diode

For best performance, the area of the loop connecting the secondary winding, the Output Diode and the Output Filter Capacitor, should be minimized. See Figure 17 for optimized layout. In addition, sufficient copper area should be provided at the anode and cathode terminals of the diode for adequately heatsinking.

Input and Output Filter Capacitors

There are constrictions in the traces connected to the input and output filter capacitors. These constrictions are present for two reasons. The first is to force all the high frequency currents to flow through the capacitor (if the trace were wide then it could flow around the capacitor). Secondly, the constrictions minimize the heat transferred from the *TinySwitch-II* to the input filter capacitor and from the secondary diode to the output filter capacitor. The common/return (the negative output terminal in Figure 17) terminal of the output filter capacitor should be connected with a short, low resistance path to the secondary winding. In addition, the common/return output connection should be taken directly from the secondary winding pin and not from the Y-capacitor connection point.

Worst Case EMI & Efficiency Measurement

Since identical *TinySwitch-II* supplies may operate at several different frequencies under the same load and line conditions, care must be taken to ensure that measurements are made under worst case conditions. When measuring efficiency or EMI verify that the *TinySwitch-II* is operating at maximum frequency and that measurements are made at high line. Maximum frequency operation can be achieved by: using a transformer at the minimum primary inductance tolerance limit; overloading the output to just before regulation is lost and then reducing the load to the rated maximum. This ensures that any parasitic capacitive losses are worst case (highest line voltage and highest switching frequency). EMI measurements should also be performed at the maximum switching frequency at both high and low line to ensure the worst case result is obtained.

For the most up-to-date information visit the PI website at: www.powerint.com

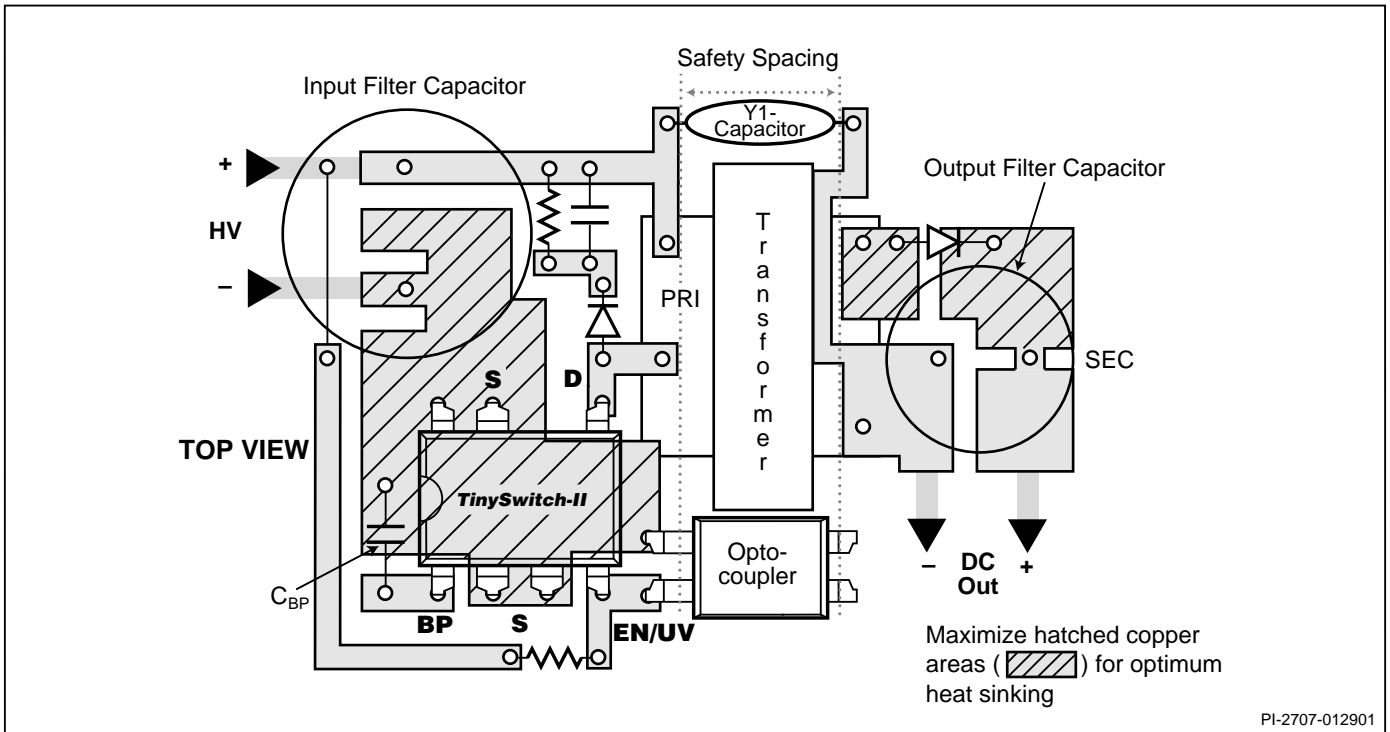


Figure 17. Recommended PC Layout for TinySwitch-II with Under-Voltage Lock Out Resistor.

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

DRAIN Voltage	- 0.3 V to 700 V	BYPASS Voltage	-0.3 V to 9 V
Peak DRAIN Current (TNY264)	400 mA	Storage Temperature	-65 to 150 °C
Peak DRAIN Current (TNY266)	560 mA	Operating Junction Temperature ⁽²⁾	-40 to 150 °C
Peak DRAIN Current (TNY267)	720 mA	Lead Temperature ⁽³⁾	260 °C
Peak DRAIN Current (TNY268)	880 mA	Notes:	
EN/UV Voltage	- 0.3 V to 9 V	1. All voltages referenced to SOURCE, T _A = 25 °C.	
EN/UV Current	100 mA	2. Normally limited by internal circuitry.	
		3. 1/16" from case for 5 seconds.	

THERMAL IMPEDANCE

Thermal Impedance: P/G Package:	Notes:
(θ_{JA}) 45 °C/W ⁽²⁾ ; 35 °C/W ⁽³⁾	1. Measured on the SOURCE pin close to plastic interface.
(θ_{JC}) ⁽¹⁾ 11 °C/W	2. Soldered to 0.36 sq. inch (232 mm ²), 2oz. (610 gm/m ²) copper clad.
	3. Soldered to 1 sq. inch (645 mm ²), 2oz. (610 gm/m ²) copper clad.

Parameter	Symbol	Conditions		Min	Typ	Max	Units
		SOURCE = 0 V; T _J = -40 to 125 °C See Figure 18 (Unless Otherwise Specified)					
CONTROL FUNCTIONS							
Output Frequency	f _{OSC}	T _J = 25 °C See Figure 4	Average	124	132	140	kHz
			Peak-Peak Jitter		±4		
Maximum Duty Cycle	DC _{MAX}	S1 Open		62	65	68	%
EN/UV Pin Turnoff Threshold Current	I _{DIS}	T _J = -40 °C to 125 °C		-300	-240	-170	µA
EN/UV Pin Voltage	V _{EN}	I _{EN/UV} = -125 µA		0.4	1.0	1.5	V
		I _{EN/UV} = 25 µA		1.3	2.3	2.7	
DRAIN Supply Current	I _{S1}	V _{EN/UV} = 0 V		320	430	500	µA
		I _{S2}	EN/UV Open (MOSFET Switching) See Note A, B	TNY264	170	225	
	TNY266			200	265	320	
	TNY267			240	315	380	
TNY268	285	380		460			
BYPASS Pin Charge Current	I _{CH1}	V _{BP} = 0 V, T _J = 25 °C See Note C, D	TNY264	-5.5	-3.3	-1.8	mA
			TNY266-268	-7.5	-4.6	-2.5	
	I _{CH2}	V _{BP} = 4 V, T _J = 25 °C See Note C, D	TNY264	-3.8	-2.0	-1.0	
			TNY266-268	-4.5	-3.0	-1.5	
BYPASS Pin Voltage	V _{BP}	See Note C		5.6	5.85	6.1	V
BYPASS Pin Voltage Hysteresis	V _{BPH}			0.80	0.95	1.10	V



Parameter	Symbol	Conditions		Min	Typ	Max	Units
		SOURCE = 0 V; $T_J = -40$ to 125 °C See Figure 18 (Unless Otherwise Specified)					
CONTROL FUNCTIONS (cont.)							
EN/UV Pin Line Under-voltage Threshold	I_{LUV}	$T_J = 25$ °C		44	49	54	μA
CIRCUIT PROTECTION							
Current Limit	I_{LIMIT}	TNY264 $T_J = 25$ °C	di/dt = 50 mA/μs See Note E	233	250	267	mA
		TNY266 $T_J = 25$ °C	di/dt = 70 mA/μs See Note E	325	350	375	
		TNY267 $T_J = 25$ °C	di/dt = 90 mA/μs See Note E	419	450	481	
		TNY268 $T_J = 25$ °C	di/dt = 110 mA/μs See Note E	512	550	588	
Initial Current Limit	I_{INIT}	See Figure 21 $T_J = 25$ °C		0.65 x $I_{LIMIT (MIN)}$			mA
Leading Edge Blanking Time	t_{LEB}	$T_J = 25$ °C See Note F		170	215		ns
Current Limit Delay	t_{ILD}	$T_J = 25$ °C See Note F, G			150		ns
Thermal Shutdown Temperature				125	135	150	°C
Thermal Shutdown Hysteresis					70		°C
OUTPUT							
ON-State Resistance	$R_{DS(ON)}$	TNY264 $I_D = 25$ mA	$T_J = 25$ °C		28	32	Ω
			$T_J = 100$ °C		42	48	
		TNY266 $I_D = 35$ mA	$T_J = 25$ °C		14	16	
			$T_J = 100$ °C		21	24	
		TNY267 $I_D = 45$ mA	$T_J = 25$ °C		7.8	9.0	
			$T_J = 100$ °C		11.7	13.5	
TNY268 $I_D = 55$ mA	$T_J = 25$ °C		5.2	6.0			
	$T_J = 100$ °C		7.8	9.0			
OFF-State Leakage	I_{DSS}	$V_{BP} = 6.2$ V, $V_{EN/UV} = 0$ V, $V_{DS} = 560$ V, $T_J = 125$ °C				100	μA
Breakdown Voltage	BV_{DSS}	$V_{BP} = 6.2$ V, $V_{EN/UV} = 0$ V, $I_{DS} = 100$ μA, $T_J = 25$ °C		700			V

Parameter	Symbol	Conditions	Min	Typ	Max	Units
		SOURCE = 0 V; $T_J = -40$ to 125 °C See Figure 18 (Unless Otherwise Specified)				
OUTPUT (cont.)						
Rise Time	t_R	Measured in a Typical Flyback Converter Application.		50		ns
Fall Time	t_F			50		ns
Drain Supply Voltage			50			V
Output EN/UV Delay	$t_{EN/UV}$	See Figure 20			10	μ s
Output Disable Setup Time	t_{DST}			0.5		μ s
Auto-Restart, ON-Time	t_{AR}	$T_J = 25$ °C See Note H		50		ms
Auto-Restart Duty Cycle	DC_{AR}			5.6		%

NOTES:

- A. Total current consumption is the sum of I_{S1} and I_{DSS} when EN/UV pin is shorted to ground (MOSFET not switching) and the sum of I_{S2} and I_{DSS} when EN/UV pin is open (MOSFET switching).
- B. Since the output MOSFET is switching, it is difficult to isolate the switching current from the supply current at the DRAIN. An alternative is to measure the BYPASS pin current at 6.1 V.
- C. BYPASS pin is not intended for sourcing supply current to external circuitry.
- D. See typical performance characteristics section for BYPASS pin start-up charging waveform.
- E. For current limit at other di/dt values, refer to Figure 25.
- F. This parameter is derived from characterization.
- G. This parameter is derived from the change in current limit measured at 5X and 10X of the di/dt shown in the I_{LIMIT} specification.
- H. Auto-restart on time has the same temperature characteristics as the oscillator (inversely proportional to frequency).

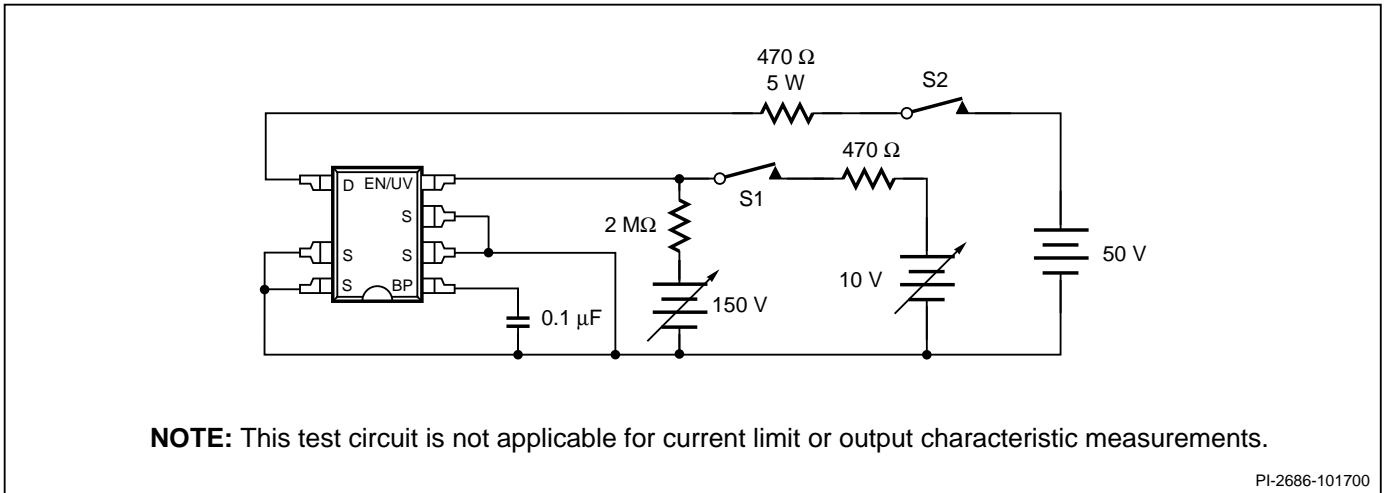


Figure 18. TinySwitch-II General Test Circuit.

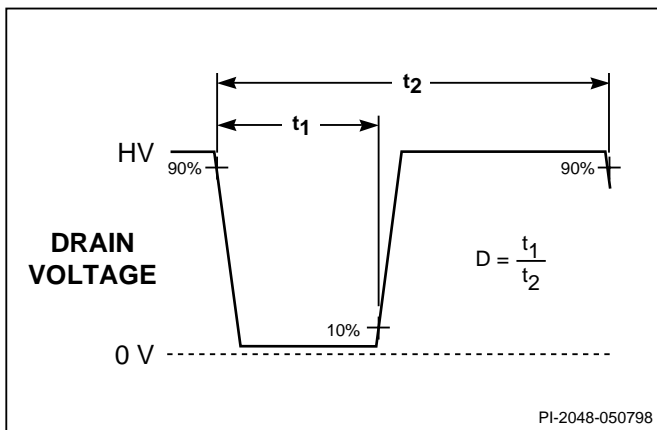


Figure 19. TinySwitch-II Duty Cycle Measurement.

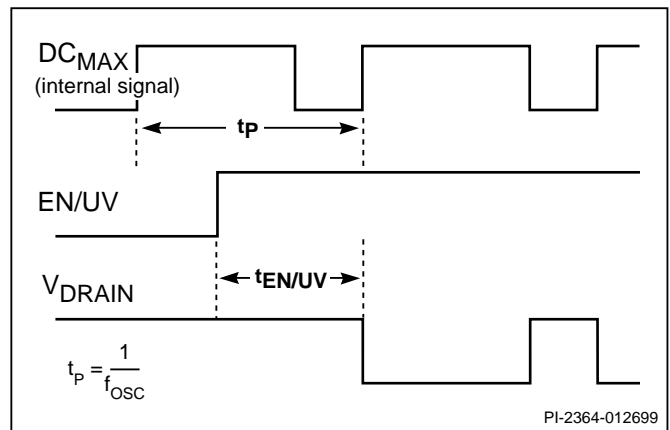


Figure 20. TinySwitch-II Output Enable Timing.

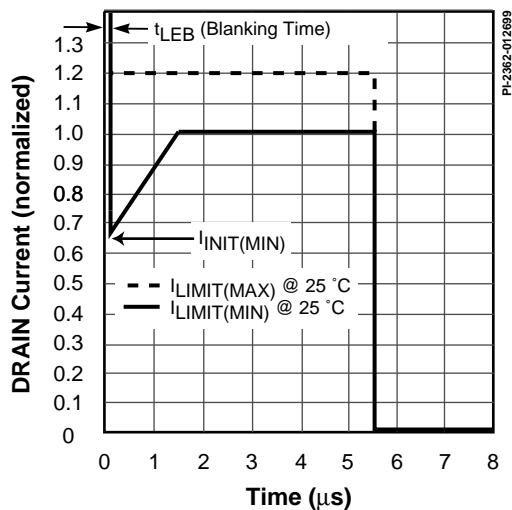


Figure 21. Current Limit Envelope.

Typical Performance Characteristics

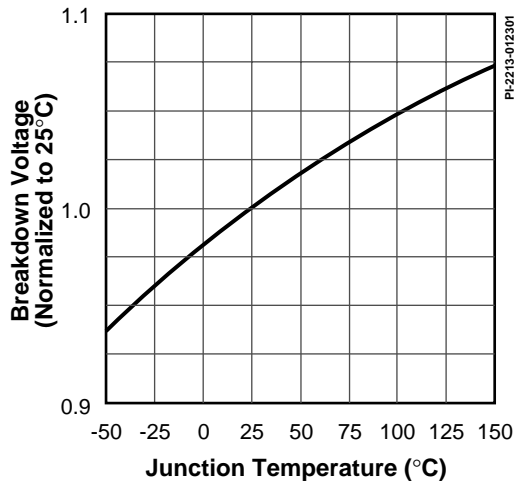


Figure 22. Breakdown vs. Temperature.

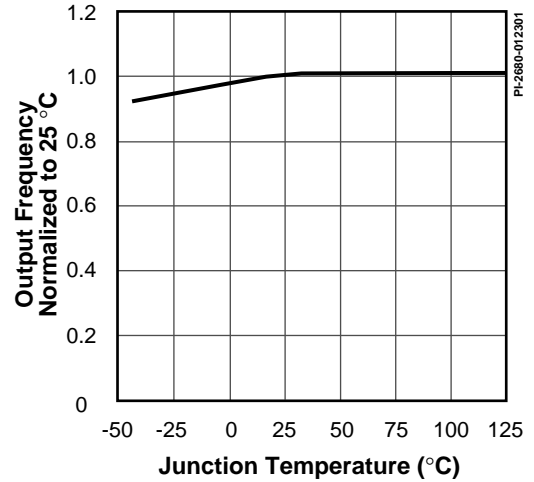


Figure 23. Frequency vs. Temperature.

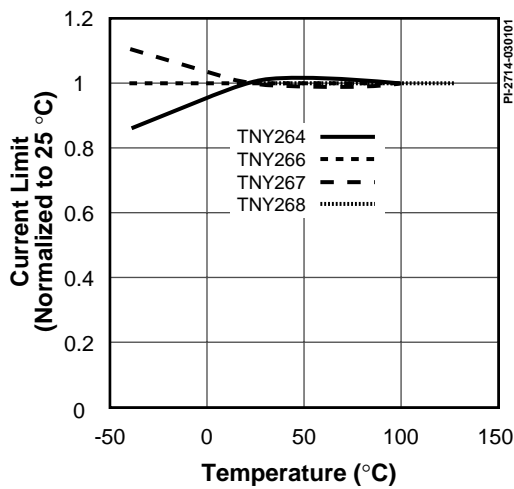


Figure 24. Current Limit vs. Temperature.

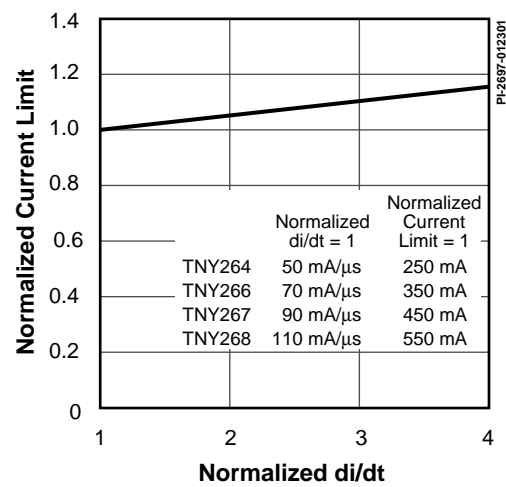


Figure 25. Current Limit vs. di/dt.

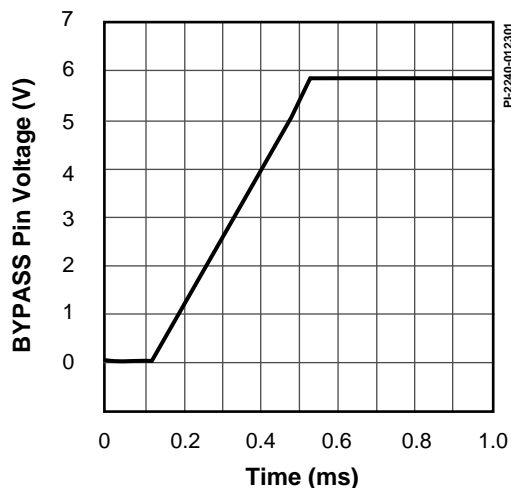


Figure 26. Bypass Pin Start-up vs. Waveform.

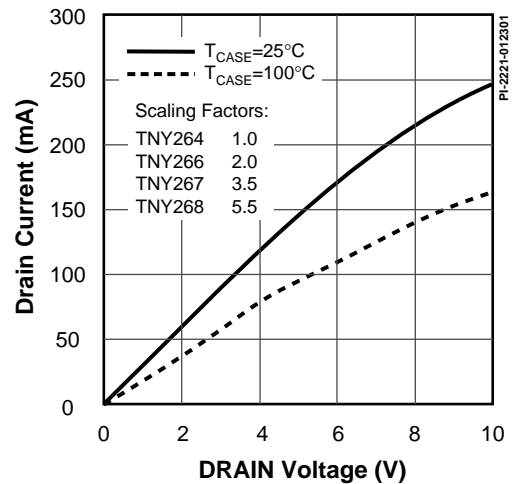


Figure 27. Output Characteristic.



Typical Performance Characteristics (cont.)

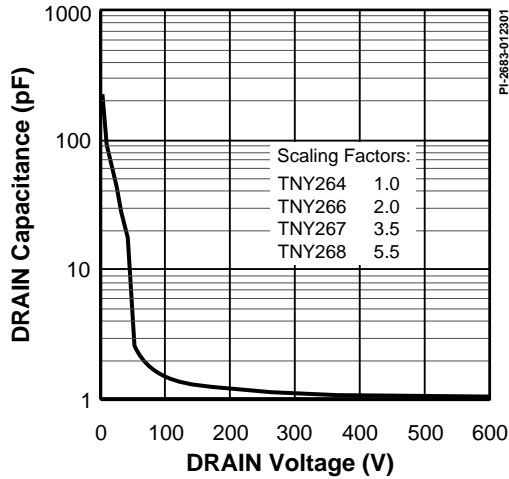


Figure 28. C_{OSS} vs. Drain Voltage.

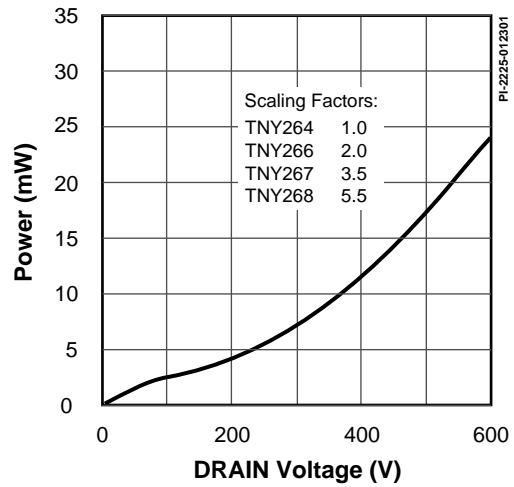


Figure 29. Drain Capacitance Power.

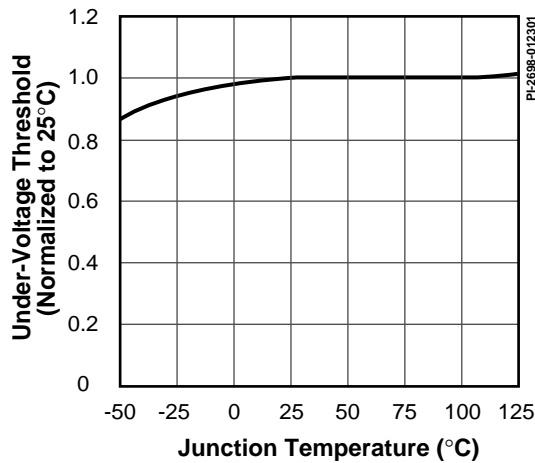
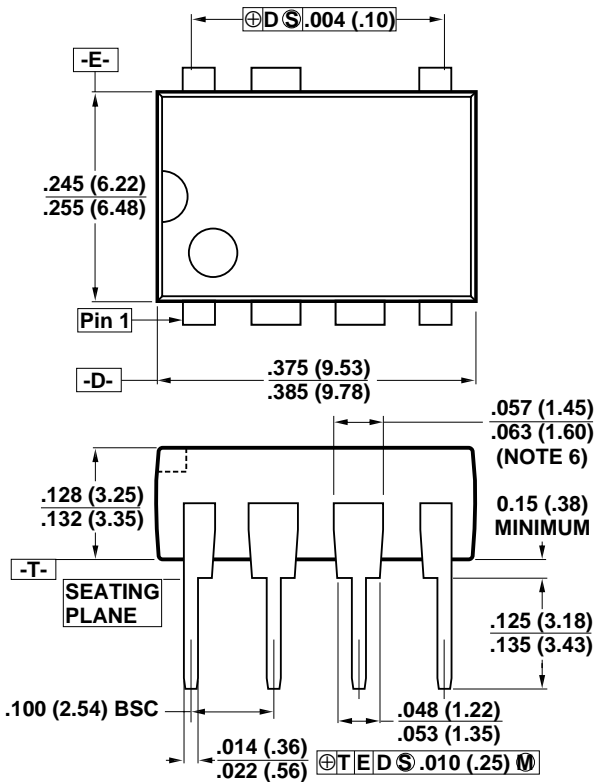


Figure 30. Undervoltage Threshold vs. Temperature.

PART ORDERING INFORMATION		
<p>TNY 264 G - TL</p>	TinySwitch Product Family	
	Series Number	
	Package Identifier	
	G	Plastic Surface Mount DIP
	P	Plastic DIP
	Package/Lead Options	
	Blank	Standard Configurations
	TL	Tape & Reel, 1 K pcs minimum, G Package only

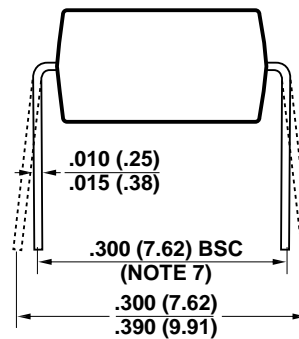


DIP-8B



Notes:

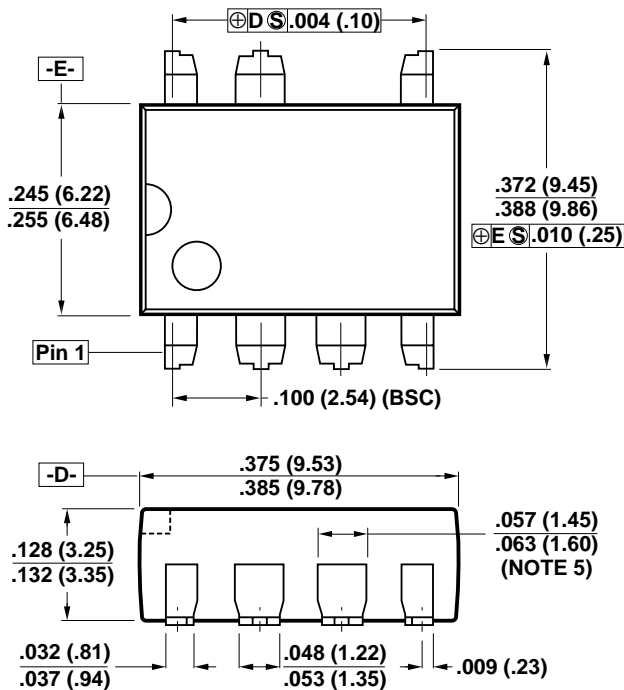
1. Package dimensions conform to JEDEC specification MS-001-AB (Issue B 7/85) for standard dual-in-line (DIP) package with .300 inch row spacing.
2. Controlling dimensions are inches. Millimeter sizes are shown in parentheses.
3. Dimensions shown do not include mold flash or other protrusions. Mold flash or protrusions shall not exceed .006 (.15) on any side.
4. Pin locations start with Pin 1, and continue counter-clockwise to Pin 8 when viewed from the top. The notch and/or dimple are aids in locating Pin 1. Pin 6 is omitted.
5. Minimum metal to metal spacing at the package body for the omitted lead location is .137 inch (3.48 mm).
6. Lead width measured at package body.
7. Lead spacing measured with the leads constrained to be perpendicular to plane T.



P08B

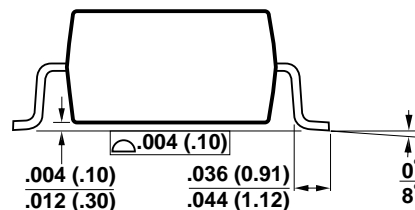
PI-2551-101599

SMD-8B



Notes:

1. Controlling dimensions are inches. Millimeter sizes are shown in parentheses.
2. Dimensions shown do not include mold flash or other protrusions. Mold flash or protrusions shall not exceed .006 (.15) on any side.
3. Pin locations start with Pin 1, and continue counter-clockwise to Pin 8 when viewed from the top. Pin 6 is omitted.
4. Minimum metal to metal spacing at the package body for the omitted lead location is .137 inch (3.48 mm).
5. Lead width measured at package body.
6. D and E are referenced datums on the package body.



G08B

PI-2546-101599



For the latest updates, visit our website: www.powerint.com

Power Integrations reserves the right to make changes to its products at any time to improve reliability or manufacturability. Power Integrations does not assume any liability arising from the use of any device or circuit described herein, nor does it convey any license under its patent rights or the rights of others.

PI Logo and **TOPSwitch** are registered trademarks of Power Integrations, Inc.
 ©Copyright 2001, Power Integrations, Inc.

**WORLD HEADQUARTERS
 NORTH AMERICA - WEST**

Power Integrations, Inc.
 5245 Hellyer Avenue
 San Jose, CA 95138 USA
 Main: +1-408-414-9200
 Customer Service:
 Phone: +1-408-414-9665
 Fax: +1-408-414-9765

**NORTH AMERICA - EAST
 & SOUTH AMERICA**

Power Integrations, Inc.
 Eastern Area Sales Office
 1343 Canton Road, Suite C1
 Marietta, GA 30066 USA
 Phone: +1-770-424-5152
 Fax: +1-770-424-6567

EUROPE & AFRICA

Power Integrations (Europe) Ltd.
 Centennial Court
 Easthampstead Road
 Bracknell
 Berkshire, RG12 1YQ
 United Kingdom
 Phone: +44-1344-462-301
 Fax: +44-1344-311-732

TAIWAN

Power Integrations International
 Holdings, Inc.
 2F, #508
 Chung-Hsiao E. Road
 Sec. 5, Taipei 105, Taiwan
 Phone: +886-2-2727-1221
 Fax: +886-2-2727-1223

CHINA

Power Integrations International
 Holdings, Inc.
 Rm# 1705 Bao Hua Bldg.
 1016 Hua Qiang Bei Lu
 Shenzhen, Guangdong
 518031 China
 Phone: +86-755-367-5143
 Fax: +86-755-377-9610

KOREA

Power Integrations International
 Holdings, Inc.
 Rm# 402, Handuk Building
 649-4 Yeoksam-Dong,
 Kangnam-Gu Seoul Korea
 Phone: +82-2-568-7520
 Fax: +82-2-568-7474

JAPAN

Power Integrations, K.K.
 Keihin-Tatemono
 1st Bldg. Shin-Yokohama
 2-12-20 Kohoku-ku,
 Yokohama-shi Kanagawa
 Japan 222-0033
 Phone: +81-45-471-1021
 Fax: +81-45-471-3717

INDIA (Technical Support)

Innovatech
 #1, 8th Main Road
 Vasanthnagar
 Bangalore, India 560052
 Phone: +91-80-226-6023
 Fax: +91-80-228-9727

APPLICATIONS HOTLINE
 World Wide +1-408-414-9660

APPLICATIONS FAX
 World Wide +1-408-414-9760

